

# N-channel 40 V 7.6 mΩ standard level MOSFET

Rev. 02 — 25 June 2009

**Product data sheet** 

## 1. Product profile

### **1.1 General description**

Standard level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

## 1.2 Features and benefits

High efficiency due to low switching and conduction losses

## **1.3 Applications**

- DC-to-DC convertors
- Load switching

## 1.4 Quick reference data

- Suitable for standard level gate drive sources
- Motor control
- Server power supplies

Table 1.	Quick reference						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{DS}$	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C		-	-	40	V
I <sub>D</sub>	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u>		-	-	77	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>		-	-	86	W
Dynamic	characteristics						
$Q_{GD}$	gate-drain charge	$\label{eq:V_GS} \begin{array}{l} V_{GS} = 10 \; V; \; I_{D} = 25 \; A; \\ V_{DS} = 20 \; V; \; see \; \underline{Figure \; 14}; \\ see \; \underline{Figure \; 15} \end{array}$		-	3.8	-	nC
Static ch	aracteristics						
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; see <u>Figure 13</u>	[1]	-	6.2	7.6	mΩ

[1] Measured 3 mm from package.



# 2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	D	drain	mb	
3	S	source		
3 mb	D	mounting base; connected to drain		mbb076 S
			SOT78 (TO-220AB)	

# 3. Ordering information

### Table 3. Ordering information

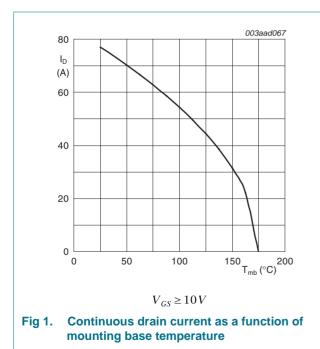
Type number	nber Package				
	Name	Description	Version		
PSMN8R0-40PS	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78		

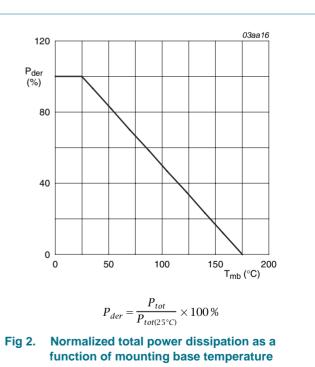
## 4. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

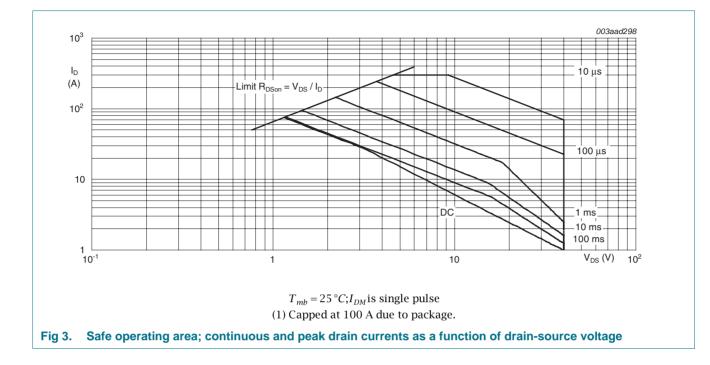
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	40	V
V <sub>DGR</sub>	drain-gate voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C; R <sub>GS</sub> = 20 kΩ	-	40	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 100 °C; see <u>Figure 1</u>	-	55	А
		V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; see <u>Figure 1</u>	-	77	А
I <sub>DM</sub>	peak drain current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$ ; see Figure 3	-	309	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	86	W
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Source-dr	ain diode				
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C	-	77	А
I <sub>SM</sub>	peak source current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$	-	309	А
Avalanche	e ruggedness				
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; $I_D$ = 77 A; $V_{sup}$ ≤ 40 V; unclamped; $R_{GS}$ = 50 $\Omega$	-	43	mJ





PSMN8R0-40PS\_2

### N-channel 40 V 7.6 mΩ standard level MOSFET



10<sup>-1</sup>

10<sup>-2</sup>

0.05

0.02

### N-channel 40 V 7.6 mΩ standard level MOSFET

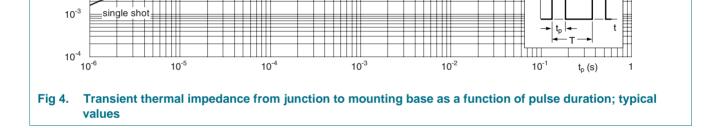
Ρ

δ

## 5. Thermal characteristics

±₽₽

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	see <u>Figure 4</u>	-	1.2	1.74	K/W
10					003aad068	
Z <sub>th(j-mb)</sub>						



## 6. Characteristics

Table 6.	Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	racteristics						
V <sub>(BR)DSS</sub>	drain-source	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ\text{C}$		36	-	-	V
	breakdown voltage	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$		40	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see <u>Figure 11</u> ; see <u>Figure 12</u>		-	-	4.6	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see Figure 11; see Figure 12		1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see Figure 11; see Figure 12		2	3	4	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 40 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	1.5	μΑ
		$V_{DS}$ = 40 V; $V_{GS}$ = 0 V; $T_j$ = 125 °C		-	-	30	μΑ
I <sub>GSS</sub>	gate leakage current	$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
		$V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C		-	-	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 100 °C; see <u>Figure 13</u>		-	-	11	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; see <u>Figure 13</u>	[2]	-	6.2	7.6	mΩ
R <sub>G</sub>	internal gate resistance (AC)	f = 1 MHz		-	1.1	-	Ω
Dynamic	characteristics						
Q <sub>G(tot)</sub> total gate charge		$I_D = 0 \text{ A}; \text{ V}_{DS} = 0 \text{ V}; \text{ V}_{GS} = 10 \text{ V}$		-	17	-	nC
		$I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V};$ see Figure 14; see Figure 15		-	21	-	nC
$Q_{GS}$	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V};$ see Figure 14; see Figure 15		-	7.2	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate-source charge	$I_D$ = 25 A; $V_{DS}$ = 20 V; $V_{GS}$ = 10 V; see Figure 14		-	3.6	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate-source charge			-	3.6	-	nC
$Q_{GD}$	gate-drain charge	$I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V};$ see Figure 14; see Figure 15		-	3.8	-	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	$I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; \text{ see } \frac{\text{Figure } 14}{14}$		-	4.8	-	V
C <sub>iss</sub>	input capacitance	$V_{DS}$ = 12 V; $V_{GS}$ = 0 V; f = 1 MHz;		-	1262	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; see <u>Figure 16</u>		-	327	-	pF
C <sub>rss</sub>	reverse transfer capacitance			-	160	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 12 V; $R_{L}$ = 0.5 Ω; $V_{GS}$ = 10 V;		-	12	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 4.7 \Omega$		-	4.7	-	ns
t <sub>d(off)</sub>	turn-off delay time			-	21	-	ns
t <sub>f</sub>	fall time			-	4.7	-	ns

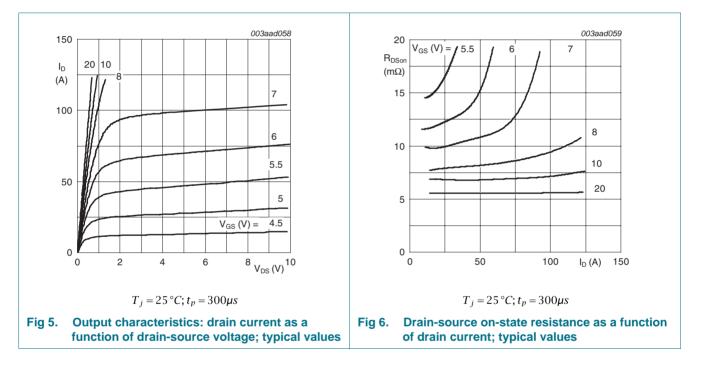
#### N-channel 40 V 7.6 m $\Omega$ standard level MOSFET

Table 0.	Characteristics continued					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Source-d	rain diode					
$V_{SD}$	source-drain voltage	$I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C};$ see <u>Figure 17</u>	-	0.85	1.2	V
t <sub>rr</sub>	reverse recovery time	$I_{S}$ = 50 A; dI_{S}/dt = -100 A/µs; V_{GS} = 0 V; $V_{DS}$ = 20 V	-	30	-	ns
Qr	recovered charge	$I_{S} = 50 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$ $V_{DS} = 20 \text{ V}; \text{ T}_{j} = 25 ^{\circ}\text{C}$	-	18	-	nC

 Table 6.
 Characteristics ...continued

[1] Tested to JEDEC standards where applicable.

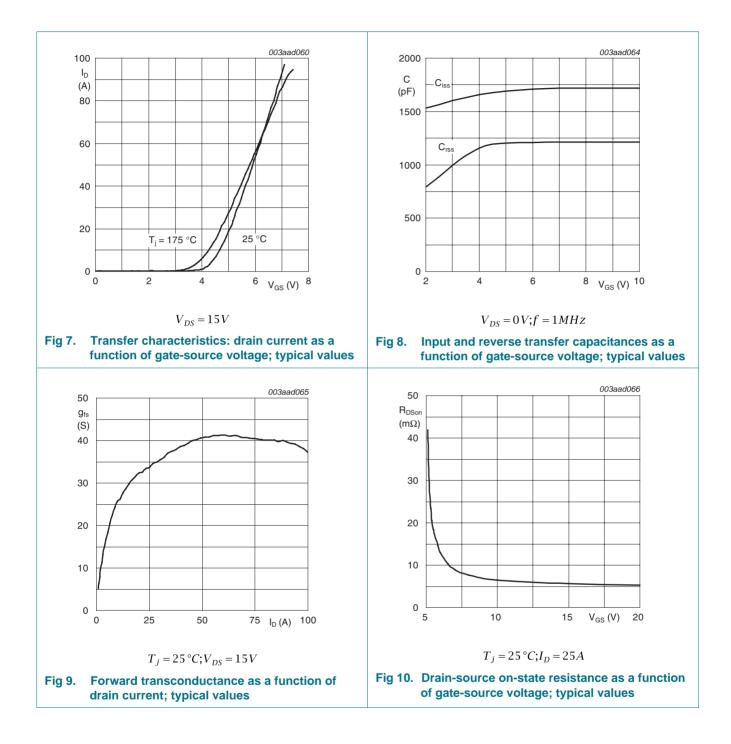
[2] Measured 3 mm from package.



## Nexperia

# PSMN8R0-40PS

#### N-channel 40 V 7.6 mΩ standard level MOSFET

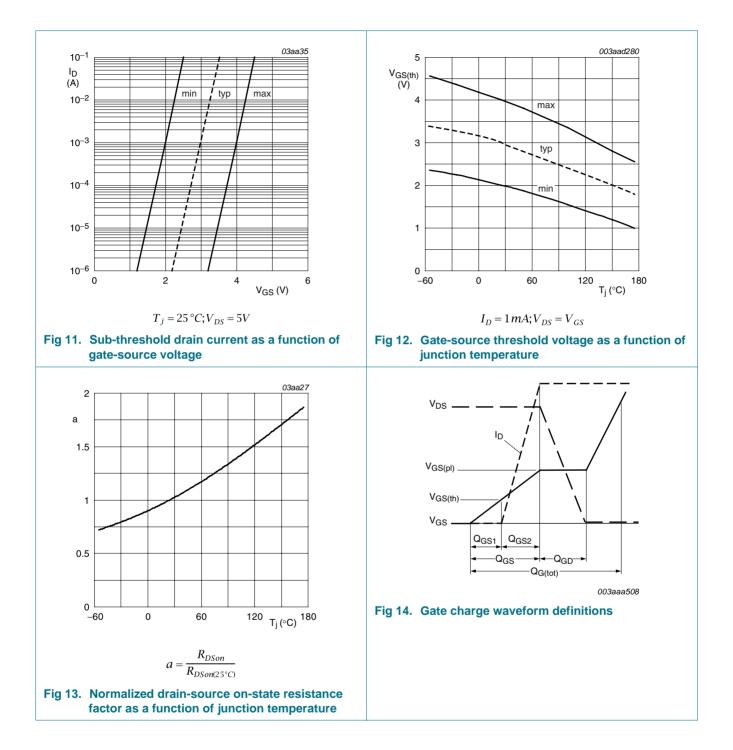


Product data sheet

## Nexperia

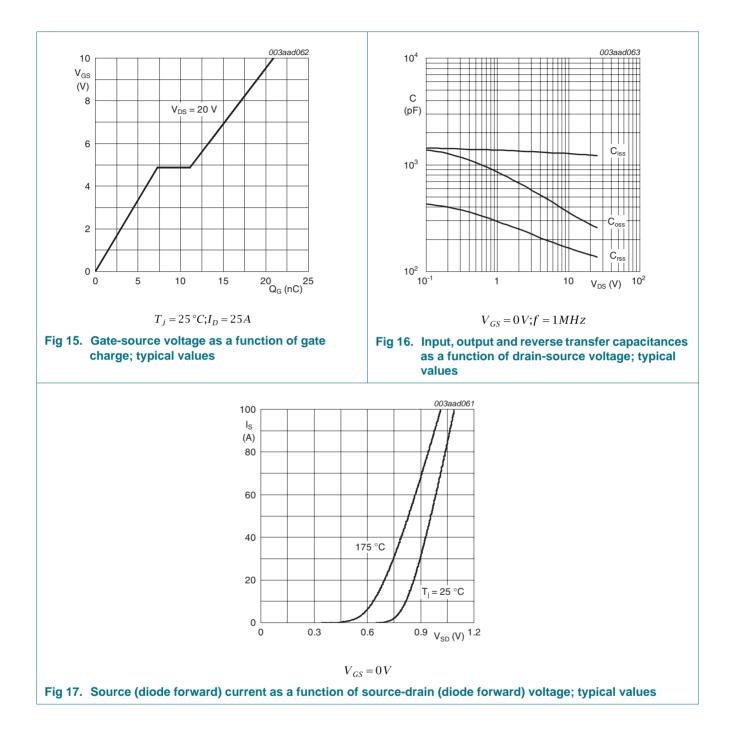
# PSMN8R0-40PS

#### N-channel 40 V 7.6 mΩ standard level MOSFET



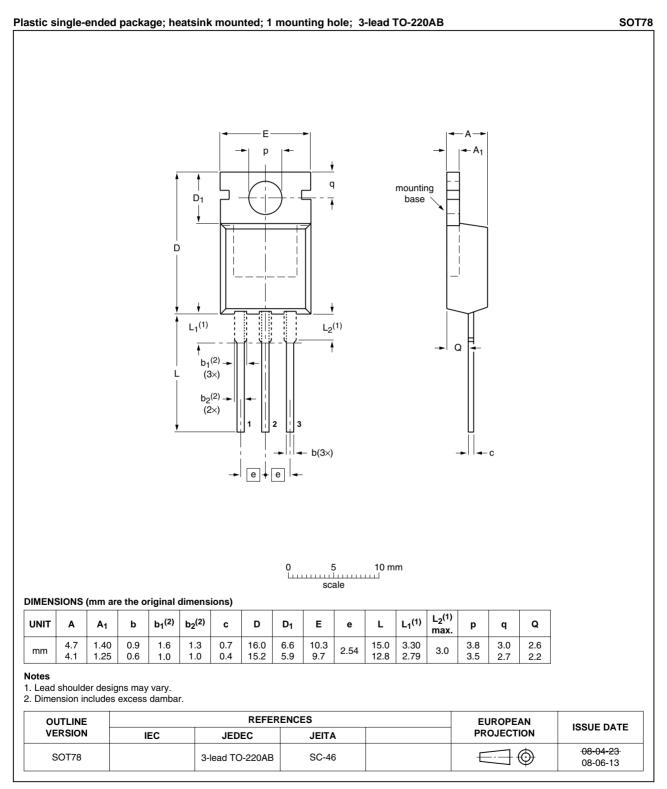
Product data sheet

#### N-channel 40 V 7.6 mΩ standard level MOSFET



### N-channel 40 V 7.6 mΩ standard level MOSFET

## 7. Package outline



#### Fig 18. Package outline SOT78 (TO-220AB)

## 8. Revision history

### Table 7.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN8R0-40PS_2	20090625	Product data sheet	-	PSMN8R0-40PS_1
Modifications:	<ul> <li>Status cha</li> </ul>	anged from objective to pr	oduct	
PSMN8R0-40PS_1	20090511	Objective data sheet	-	-

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## 9.1 Data sheet status

Document status [1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions"

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Product data sheet

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